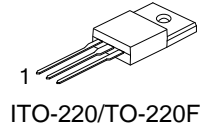
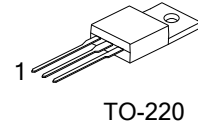
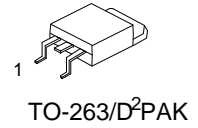
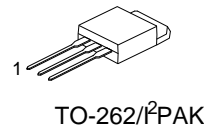


### 10 Amps, 600/650 Volts N-CHANNEL POWER MOSFET



#### DESCRIPTION

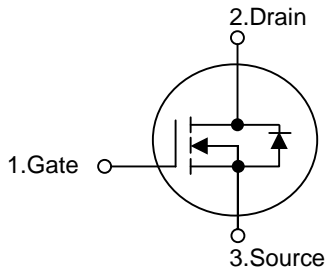
**10N60 10N65** is a high voltage and high current power MOSFET, designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and have a high rugged avalanche characteristics. This power MOSFET is usually used at high speed switching applications in power supplies, PWM motor controls, high efficient DC to DC converters and bridge circuits.



#### FEATURES

- \* 10A, 600V,  $R_{DS(ON)} = 0.73\Omega @ V_{GS} = 10V$
- \* Low gate charge ( typical 44 nC)
- \* Low  $C_{rss}$  ( typical 18 pF)
- \* Fast switching
- \* 100% avalanche tested
- \* Improved dv/dt capability

#### SYMBOL



#### ORDERING INFORMATION

Ordering Number	Package	Pin Assignment		
		1	2	3
10N60	TO-220	G	D	S
	ITO-220/TO-220F	G	D	S
10N65	TO-262/I <sup>2</sup> PAK	G	D	S
	TO-263/D <sup>2</sup> PAK	G	D	S

Note: Pin Assignment: G: Gate D: Drain S: Source

Part No.	Package	Packing
10N6*-TU	TO-220	50pcs / Tube
10N6*-TU	ITO-220/TO-220F	50pcs / Tube
10N6*-TU	TO-262	50pcs / Tube
10N6*-TU	TO-263	50pcs / Tube
10N6*-TR	TO-263	800pcs / 13" Reel

■ ABSOLUTE MAXIMUM RATINGS ( $T_C = 25^\circ\text{C}$ , unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage	10N60	$V_{DSS}$	600	V
	10N65		650	V
Gate-Source Voltage		$V_{GSS}$	$\pm 30$	V
Avalanche Current (Note 2)		$I_{AR}$	10	A
Drain Current	Continuous	$I_D$	10	A
	Pulsed (Note 2)	$I_{DM}$	38.0	A
Avalanche Energy	Single Pulsed (Note 3)	$E_{AS}$	700	mJ
	Repetitive (Note 2)	$E_{AR}$	15.6	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	4.5	V/ns
Power Dissipation	TO-220	$P_D$ ( $T_C = 25^\circ\text{C}$ )	156	W
	TO-220F		50	W
	TO-263/D <sup>2</sup> PAK		178	W
Junction Temperature		$T_J$	+150	$^\circ\text{C}$
Ambient Operating Temperature		$T_{OPR}$	-55 ~ +150	$^\circ\text{C}$
Storage Temperature		$T_{STG}$	-55 ~ +150	$^\circ\text{C}$

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repetitive Rating : Pulse width limited by  $T_J$

3.  $L=7.3\text{mH}$ ,  $I_S=10\text{A}$ ,  $V_{DD}=50\text{V}$ ,  $R_G=25\ \Omega$ , Starting  $T_J = 25^\circ\text{C}$

4.  $I_{SD} \leq 9.5\text{A}$ ,  $di/dt \leq 200\text{A}/\mu\text{s}$ ,  $V_{DD} \leq BV_{DSS}$ , Starting  $T_J = 25^\circ\text{C}$

■ THERMAL DATA

PARAMETER		SYMBOL	RATINGS	UNIT
Junction-to-Ambient	TO-262/I <sup>2</sup> PAK	$\theta_{JA}$	62.5	$^\circ\text{C}/\text{W}$
	TO-263/D <sup>2</sup> PAK		62.5	
	TO-220		62.5	
	ITO-220/TO-220F		62.5	
Junction-to-Case	TO-262/I <sup>2</sup> PAK	$\theta_{JC}$	0.85	$^\circ\text{C}/\text{W}$
	TO-263/D <sup>2</sup> PAK		0.85	
	TO-220		0.85	
	ITO-220/TO-220F		2.60	

■ ELECTRICAL CHARACTERISTICS ( $T_J=25^\circ\text{C}$ , unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
<b>OFF CHARACTERISTICS</b>						
Drain-Source Breakdown Voltage	10N60	$V_{GS} = 0V, I_D = 250\mu A$	600			V
	10N65		650			V
Drain-Source Leakage Current	$I_{DSS}$	$V_{DS} = 600V, V_{GS} = 0V$			1	$\mu A$
Gate-Source Leakage Current	Forward	$V_{GS} = 30V, V_{DS} = 0V$ $V_{GS} = -30V, V_{DS} = 0V$			100	nA
	Reverse				-100	nA
Breakdown Voltage Temperature Coefficient	$\Delta BV_{DSS}/\Delta T_J$	$I_D = 250\mu A$ , Referenced to $25^\circ\text{C}$		0.7		$^\circ\text{C}^{-1}$
<b>ON CHARACTERISTICS</b>						
Gate Threshold Voltage	$V_{GS(TH)}$	$V_{DS} = V_{GS}, I_D = 250\mu A$	2.0		4.0	V
Static Drain-Source On-State Resistance	$R_{DS(ON)}$	$V_{GS} = 10V, I_D = 4.75A$		0.6	0.73	$\Omega$
<b>DYNAMIC CHARACTERISTICS</b>						
Input Capacitance	$C_{ISS}$	$V_{DS} = 25V, V_{GS} = 0V, f = 1\text{MHz}$		1570	2040	pF
Output Capacitance	$C_{OSS}$			166	215	pF
Reverse Transfer Capacitance	$C_{RSS}$			18	24	pF
<b>SWITCHING CHARACTERISTICS</b>						
Turn-On Delay Time	$t_{D(ON)}$	$V_{DD} = 300V, I_D = 10A,$ $R_G = 25\Omega$ (Note 1, 2)		23	55	ns
Turn-On Rise Time	$t_R$			69	150	ns
Turn-Off Delay Time	$t_{D(OFF)}$			144	300	ns
Turn-Off Fall Time	$t_F$			77	165	ns
Total Gate Charge	$Q_G$	$V_{DS} = 480V, V_{GS} = 10V,$ $I_D = 10A$ (Note 1, 2)		44	57	nC
Gate-Source Charge	$Q_{GS}$			6.7		nC
Gate-Drain Charge	$Q_{GD}$			18.5		nC
<b>DRAIN-SOURCE DIODE CHARACTERISTICS</b>						
Drain-Source Diode Forward Voltage	$V_{SD}$	$V_{GS} = 0V, I_{SD} = 10A$			1.4	V
Continuous Drain-Source Current	$I_{SD}$				10	A
Pulsed Drain-Source Current	$I_{SM}$				38	A
Reverse Recovery Time	$t_{RR}$	$V_{GS} = 0V, I_{SD} = 10A,$		420		ns
Reverse Recovery Charge	$Q_{RR}$	$di/dt = 100 A/\mu s$ (Note1)		4.2		$\mu C$

Notes: 1. Pulse Test: Pulse width  $\leq 300\mu s$ , Duty cycle  $\leq 2\%$

2. Essentially independent of operating temperature

■ TEST CIRCUITS AND WAVEFORMS

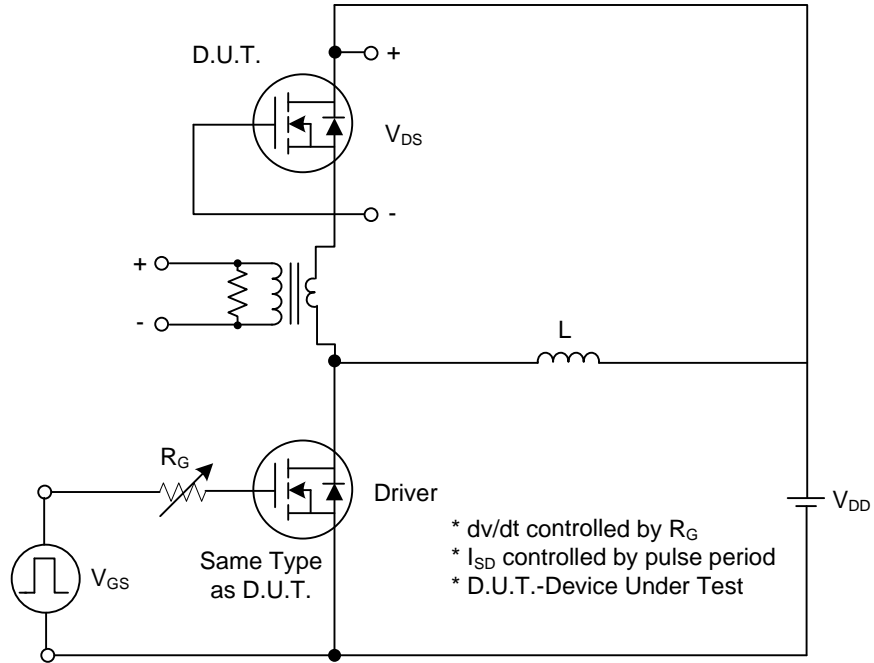


Fig. 1A Peak Diode Recovery  $dv/dt$  Test Circuit

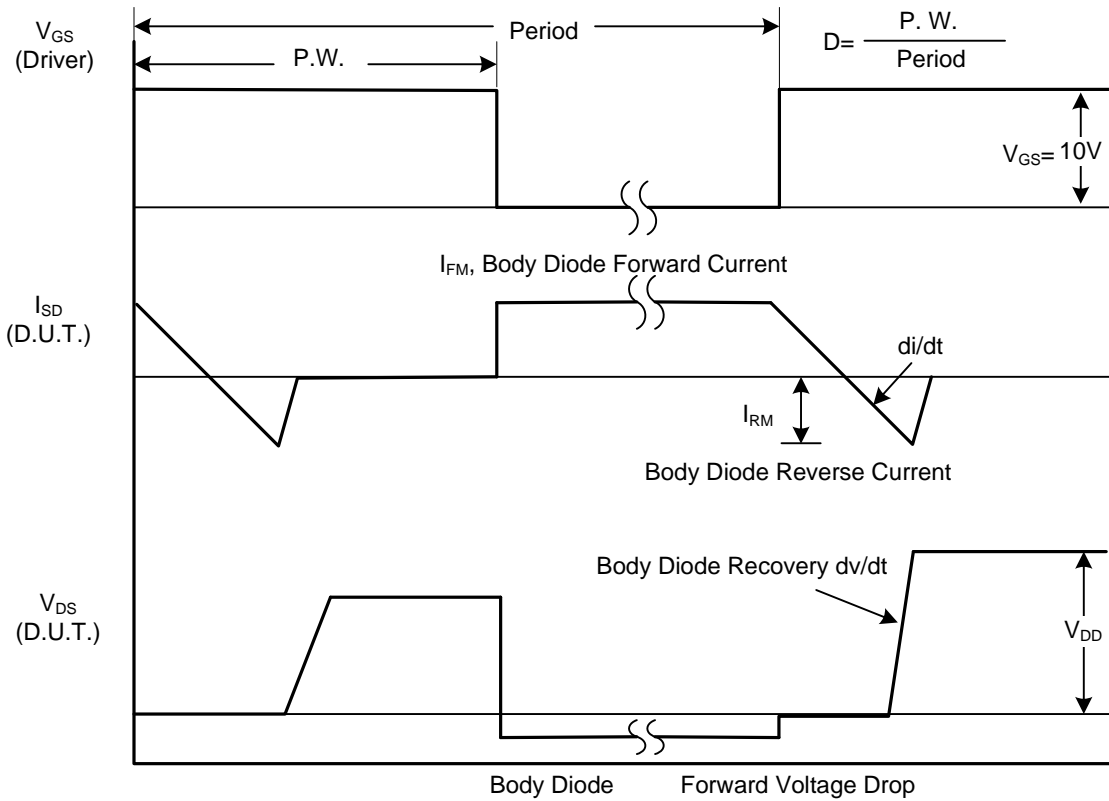


Fig. 1B Peak Diode Recovery  $dv/dt$  Waveforms

■ TEST CIRCUITS AND WAVEFORMS (Cont.)

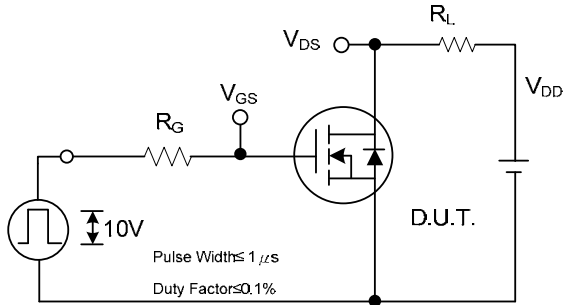


Fig. 2A Switching Test Circuit

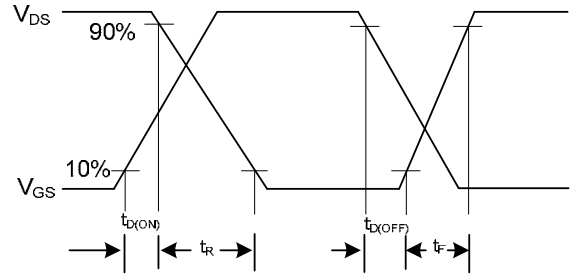


Fig. 2B Switching Waveforms

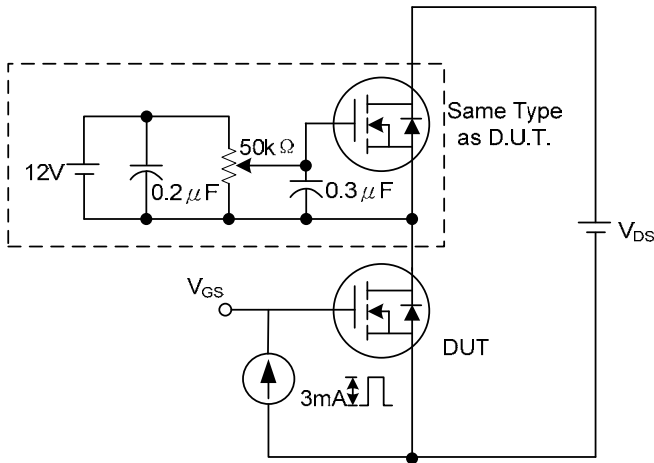


Fig. 3A Gate Charge Test Circuit

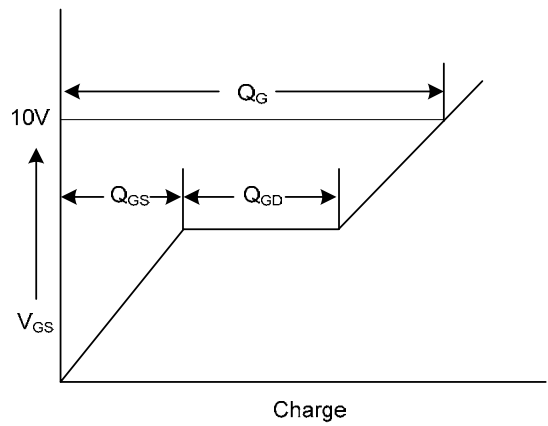


Fig. 3B Gate Charge Waveform

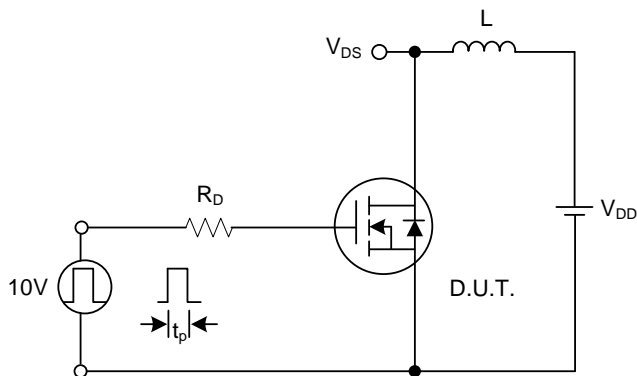


Fig. 4A Unclamped Inductive Switching Test Circuit

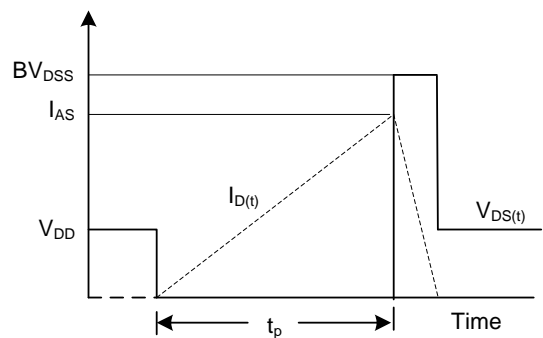
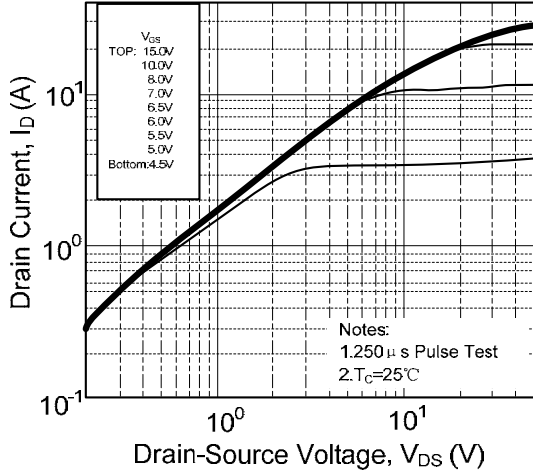


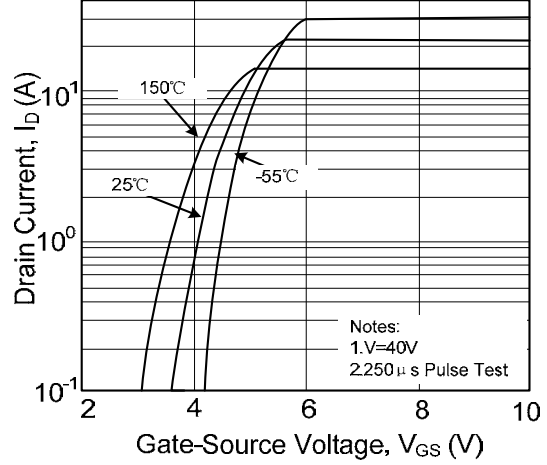
Fig. 4B Unclamped Inductive Switching Waveforms

### TYPICAL CHARACTERISTICS

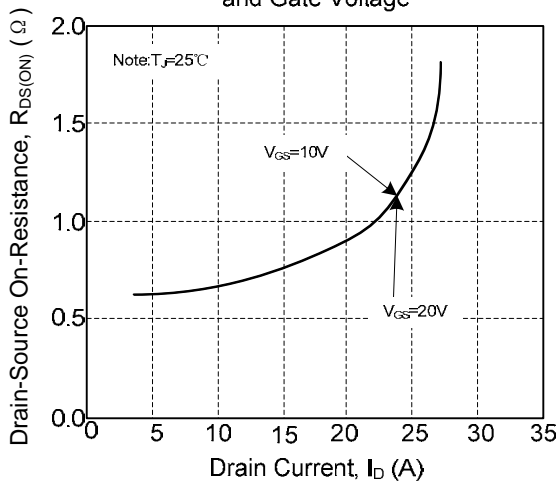
On-Region Characteristics



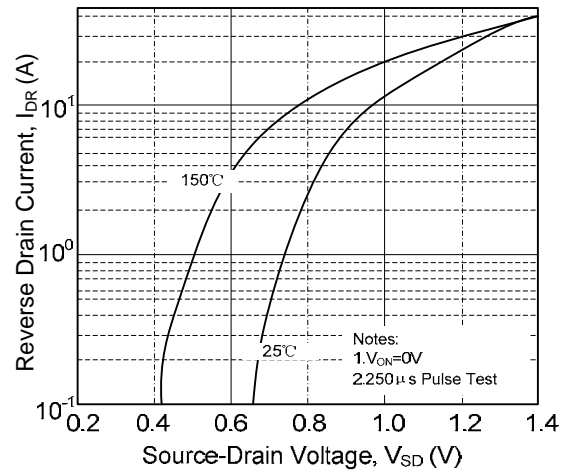
Transfer Characteristics



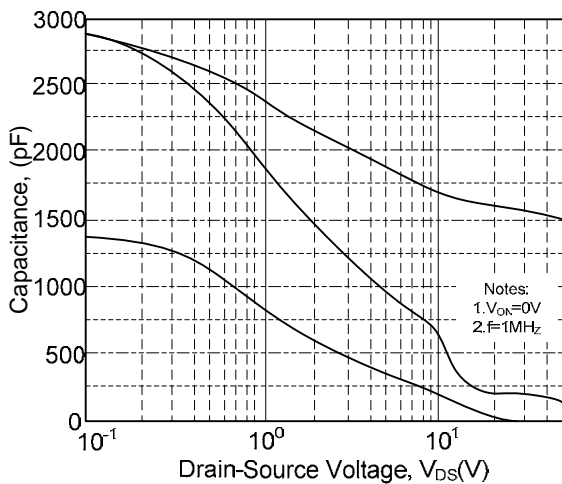
On-Resistance Variation vs. Drain Current and Gate Voltage



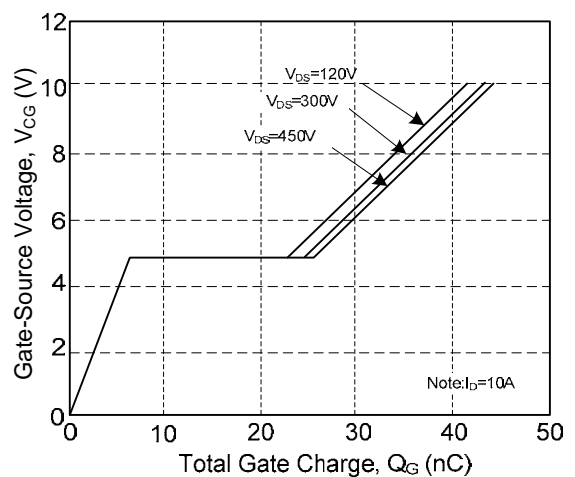
Body Diode Forward Voltage Variation with Source Current and Temperature



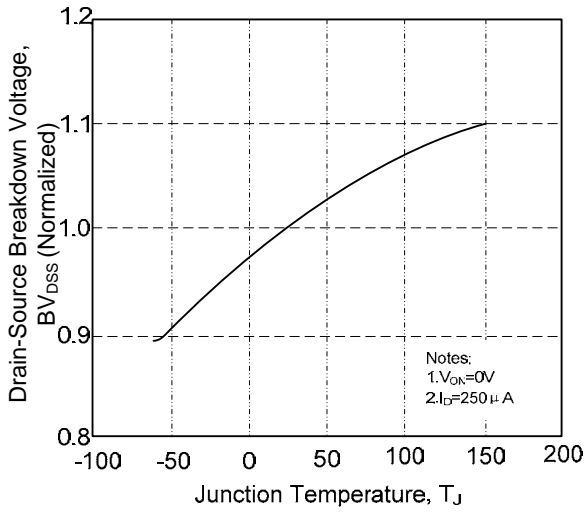
Capacitance Characteristics



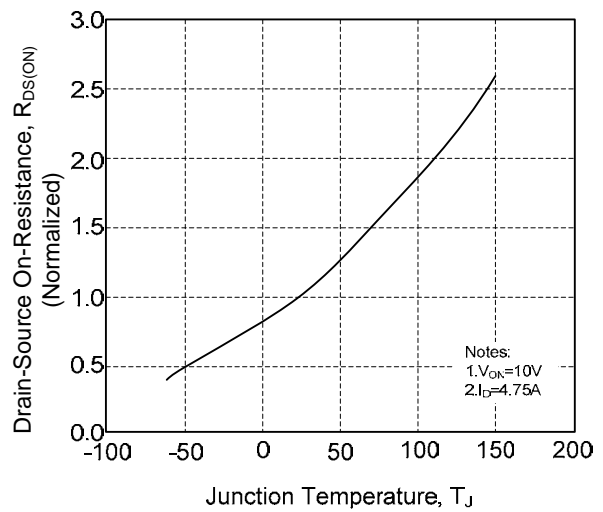
Gate Charge Characteristics



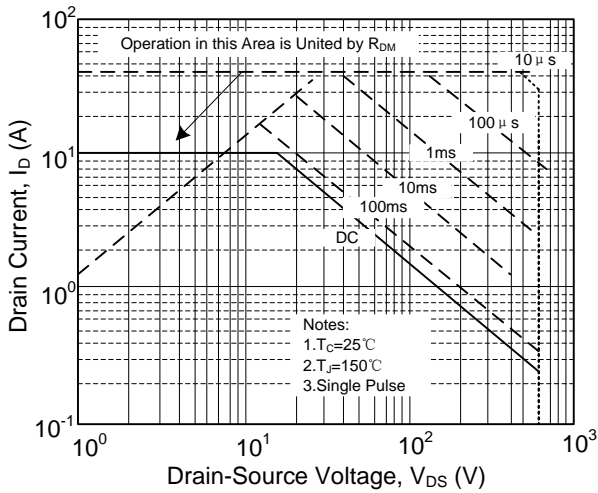
Breakdown Voltage Variation vs. Temperature



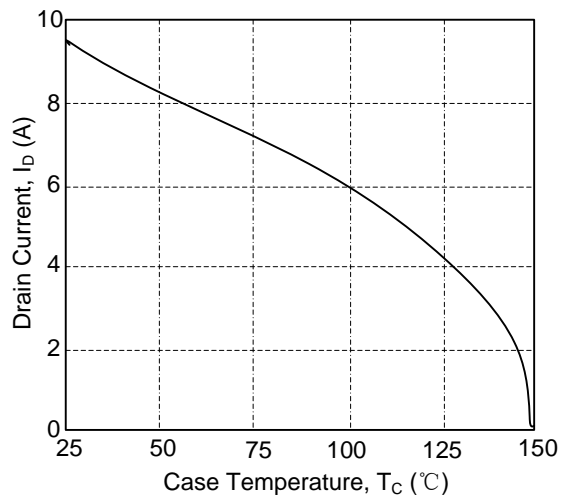
On-Resistance Variation vs. Temperature



Maximum Safe Operating Area



Maximum Drain Current vs. Case Temperature



Transient Thermal Response Curve

